



**Spec No.: DS20-2012-0121**Effective Date: 10/25/2012

Revision: -

**LITE-ON DCC** 

**RELEASE** 

BNS-OD-FC001/A4

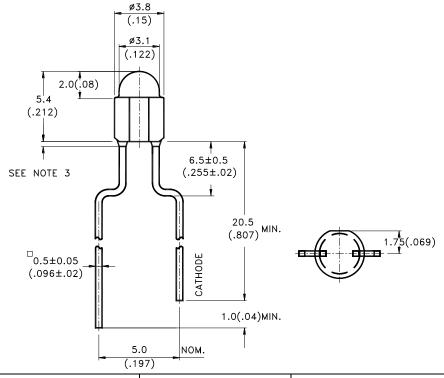


Property of Lite-On Only

#### **Features**

- \* Lead (Pb) free product RoHS compliant.
- \* High luminous intensity output.
- \* Low power consumption.
- \* High efficiency.
- \* Versatile mounting on P.C. Board or panel.
- \* I.C. Compatible/low current requirement.
- \* Popular T-1 diameter package.

#### **Package Dimensions**



Part No.	Lens	Source Color
LTL17KGH5D-041A	Green Diffused	AlInGaP Green

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25$ mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

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## Absolute Maximum Ratings at TA=25°C

Parameter	Maximum Rating	Unit	
Power Dissipation	75	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	90	mA	
Continuous Forward Current	30	mA	
Derating Linear From 50°C	0.66	mA/°C	
Operating Temperature Range	-40°C to + 80°C		
Storage Temperature Range	-55°C to + 100°C		
Lead Soldering Temperature [2 mm(.0787") From Body]	260°C for 5 Seconds Max.		

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#### Property of Lite-On Only

#### Electrical / Optical Characteristics at T<sub>A</sub>=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	110	180	520	mcd	I <sub>F</sub> = 20mA Note 1
Viewing Angle	201/2	-	50	-	deg	Note 2 (Fig.5)
Peak Emission Wavelength	λр	-	574	-	nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	566	571	578	nm	Note 4
Spectral Line Half-Width	Δλ	-	11	-	nm	
Forward Voltage	VF	-	2.1	2.4	V	I <sub>F</sub> = 20mA
Reverse Current	$I_R$	-	-	100	μΑ	$V_R = 5V$ , Note 5

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 5. Reverse voltage (V<sub>R</sub>) condition is applied for IR test only. The device is not designed for reverse operation.

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### Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

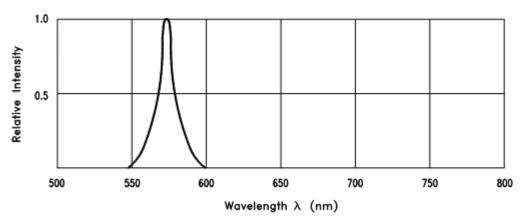
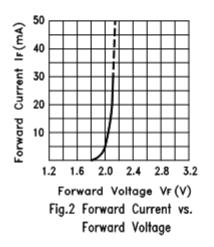


Fig.1 Relative Intensity vs. Wavelength



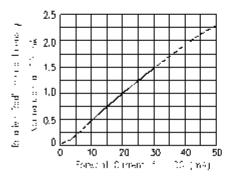
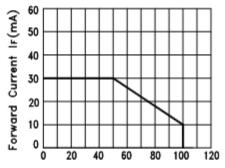


Fig.4 Forward Current v.s Radiometric Intensity



Ambient Temperature TA(\*C) Fig.3 Forward Current Derating Curve

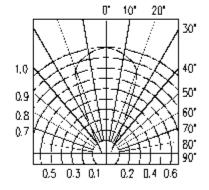


Fig.5 Spotial Distribution

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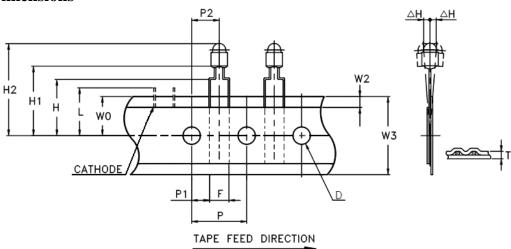


### Property of Lite-On Only

#### **Features**

- \* Compatible with radial lead automatic insertion equipment.
- \* Most radial lead plastic lead lamps available packaged in tape and reel.
- \* 5mm (0.197") formed lead spacing available.
- \* Reel packaging simplifies handling and testing.
- \* Ammo packing series lamp type 24 LED+GAP.

### **Package Dimensions**



		Specification				
Item	Symbol	Minimum		Maximum		
		mm	inch	mm	inch	
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165	
Component Lead Pitch	F	4.8	0.188	5.8	0.228	
Front to Rear Deflection	ΔΗ			2.0	0.078	
Height of Seating Plane	Н	15.5	15.5 0.610		0.649	
Feed Hole to Bottom of Component	H1	21.5	0.846	23.5	0.925	
Feed Hole to Overall Component Height	H2	26.6	1.047	29.2	1.149	
Lead Length After Component Height	L	W0		11.0	0.433	
Feed Hole Pitch	P	12.4	0.488	13.0	0.511	
Lead Location	P1	3.15	0.124	4.55	0.179	
Center of Component Location	P2	5.05	0.198	7.65	0.301	
Total Taped Thickness	T			0.90	0.035	
Feed Hole Location	W0	8.5	0.334	9.75	0.384	
Adhesive Tape Position	W2	0	0	3.0	0.118	
Tape Width	W3	17.5	0.689	19.0	0.748	

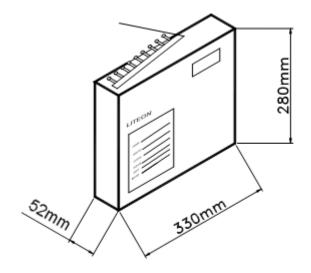
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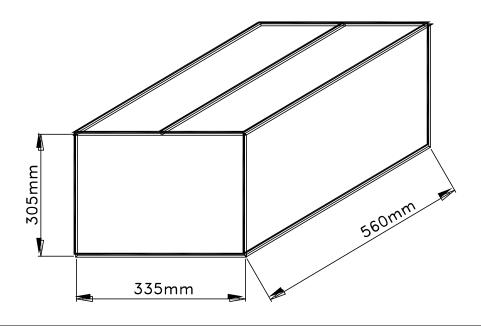
## Packing Spec

## 3,000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton, total 30,000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



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## **Bin Table Specification**

Luminous Int	Luminous Intensity Unit:			
Bin Code	Min.	Max.		
FG	110	180		
НЈ	180	310		
KL	310	520		

Note: Tolerance of each bin limit is  $\pm 15\%$ 

Dominant Wavelength Ur		nm @20mA
Bin Code	Min.	Max.
H06	566.0	568.0
H07	568.0	570.0
H08	570.0	572.0
H09	572.0	574.0
H10	574.0	576.0
H11	576.0	578.0

Note: Tolerance of each bin limit is  $\pm 1$ nm

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### **CAUTIONS**

#### 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### 4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 2mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 5. Soldering

When soldering, For Lamp without stopper type and must be leave a minimum of 2mm clearance from the base of the lens to the soldering point. To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, Dipping the lens into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature Soldering time	350°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hold type LED lamp product.

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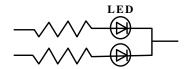
### Property of Lite-On Only

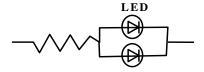
#### 6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

#### Circuit model A

#### Circuit model B





- (A) Recommended circuit
  - (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

#### 7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

ESD-damaged Leeds will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light up" at low currents. To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

Chip ESD level	Machine Model	Human Body Model
InGaN / Sapphire	100 V	300 V
AlInGaP	200 V	500 V
InGaN / SiC	600 V	1000 V

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#### Suggested checking list:

#### Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

#### **Device Handling**

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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### 8. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under room temperature as per data sheet maximum rating. *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
Endurance Test	High Temperature High Humidity Storage	Ta= $65\pm5$ °C RH= $90 \sim 95\%$ Test Time= $240$ HRS $\pm2$ HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)
	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins 10  Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)
Environmental	Thermal Shock	105 ± 5 °C ~ -55 °C ± 5 °C 10mins 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Test	Solder Resistance	T.sol = 260 °C Max. Dwell Time= 5secs Max.	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
	Solderability	T. sol = $230 \pm 5$ °C Dwell Time= $5 \pm 1$ secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

#### 9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

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